SAMPLE PTSM 0,5/ 8-2,5-H SMDWH - PCB terminal block

1820987

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Printed circuit board terminal, nominal current: 6 A, rated voltage (III/2): 160 V, nominal cross section: 0.5 mm^2, number of potentials: 8, number of rows: 1, number of positions per row: 8, product range: PTSM 0,5/..-H-SMD WH, pitch: 2.5 mm, connection method: Push-in spring connection, mounting: SMD soldering, conductor/PCB connection direction: 0 °, color: signal white, Pin layout: Linear pad geometry, number of solder pins per potential: 1, type of packaging: packed in cardboard. SAMPLE set with 5 items in belt section. When used as part of soldering process, please use items without SAMPLE marking

Your advantages

- White design: Stable color when welding and during use
- Time saving push-in connection, tools not required
- Defined contact force ensures that contact remains stable over the long term
- High current carrying capacity of 6 A in very compact dimensions
- Designed for integration into the SMT soldering process
- Additional solder anchors reduce the mechanical strain on the soldering spots

Commercial data

Item number	1820987
Packing unit	5 pc
Minimum order quantity	5 pc
Note	Made to order (non-returnable)
Product key	AAKDAB
GTIN	4046356787666
Weight per piece (including packing)	2.29 g
Weight per piece (excluding packing)	2.22 g
Customs tariff number	85369010
Country of origin	DE

Technical data

Product properties

Product type	Printed circuit board terminal
Product family	PTSM 0,5/..-H-SMD WH
Product line	COMBICON Terminals XS
Number of positions	8
Pitch	2.5 mm
Number of connections	8
Number of rows	1
Number of potentials	8
Pin layout	Linear pad geometry
Solder pins per potential	1

Data management status

Article revision	00

Electrical properties

Nominal current I_N	6 A
Nominal voltage U_N	160 V
Rated voltage (III/3)	63 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

Connection data

Connection technology

Nominal cross section	0.5 mm²

Conductor connection

Connection method	Push-in spring connection
Conductor cross section rigid	0.14 mm² ... 0.5 mm²
Conductor cross section flexible	0.2 mm² ... 0.5 mm² (up to 0.75 mm² supported, with a stripping length of 7.5 mm and a rated insulation voltage of 32 V at III/2)
Conductor cross section AWG	26 ... 20
Conductor cross section flexible, with ferrule without plastic sleeve	0.25 mm² ... 0.5 mm²
Conductor cross section, flexible, with ferrule, with plastic sleeve	0.25 mm² ... 0.34 mm² (possible from 0.14 mm², when using ferrule AI 0.14- 6 GY in combination with crimping pliers CRIMPFOX 10T-F)
Cylindrical gauge a x b / diameter	- / 1.2 mm
Stripping length	6 mm

Mounting

Mounting type	SMD soldering
Pin layout	Linear pad geometry

Processing notes

Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T_c	260 °C
Solder cycles in the reflow	3

Material specifications

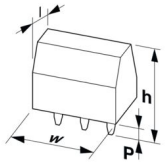
Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	hot-dip tin-plated
Metal surface terminal point (top layer)	Tin (4 - 8 µm Sn)
Metal surface soldering area (top layer)	Tin (4 - 8 µm Sn)

Material data - housing

Color (Housing)	signal white (9003)
Insulating material	PA GF
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	
Pitch	2.5 mm
Width [w]	21.9 mm
Height [h]	5.12 mm
Length [l]	11 mm
Installed height	5 mm

PCB design

Pad geometry	1.4 x 3.4 mm
Pin spacing	2.5 mm

Mechanical tests

Connection test

Specification	IEC 60998-2-2:2002-12
Result	Test passed

Test for conductor damage and slackening

Specification	IEC 60998-2-2:2002-12
Result	Test passed

Pull-out test

Specification	IEC 60998-2-2:2002-12
Conductor cross section/conductor type/tractive force setpoint/actual value	0.14 mm² / solid / > 10 N
	0.2 mm² / flexible / > 10 N
	0.5 mm² / solid / > 20 N
	0.75 mm² / flexible / > 30 N

Flexion test

Specification	IEC 60998-2-2:2002-12
Result	Test passed

Electrical tests

Temperature-rise test

Specification	IEC 60998-2-1:2002-12
Requirement temperature-rise test	Increase in temperature ≤ 45 K

Insulation resistance

Specification	IEC 60998-1:2002-12
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	63 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	1.6 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.5 mm
Rated insulation voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Glow-wire test

Specification	IEC 60998-1:2002-12
Temperature	850 °C
Time of exposure	5 s

Ambient conditions

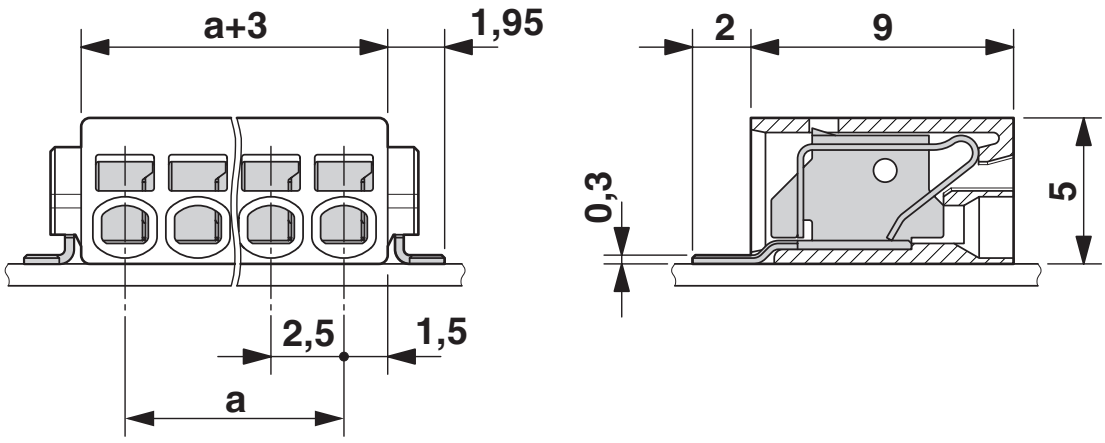
Ambient temperature (operation)	-40 °C ... 100 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C

Packaging specifications

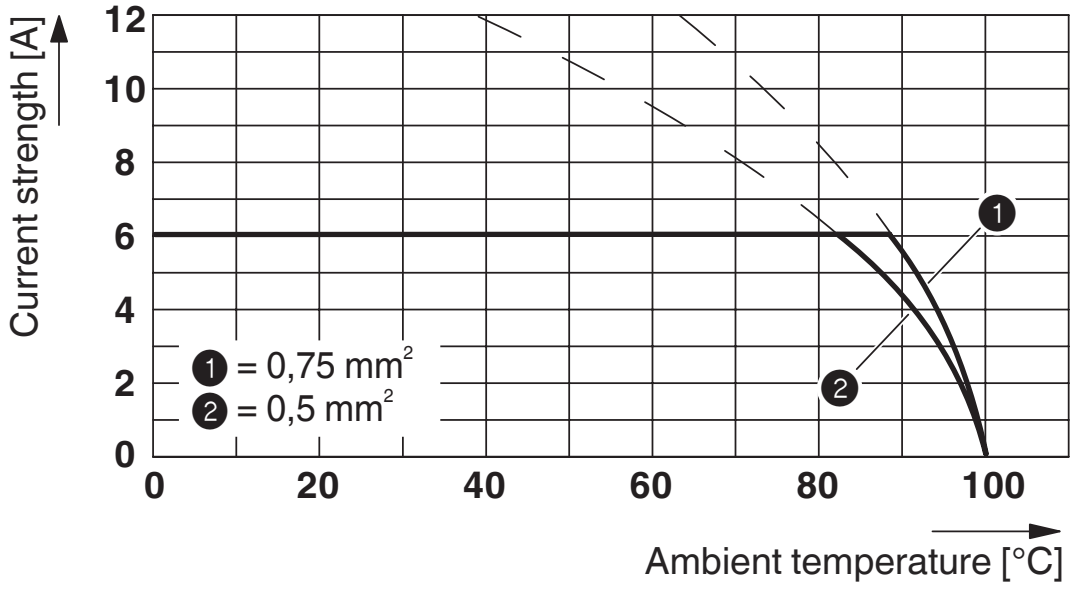
Type of packaging	packed in cardboard

Drawings

Dimensional drawing

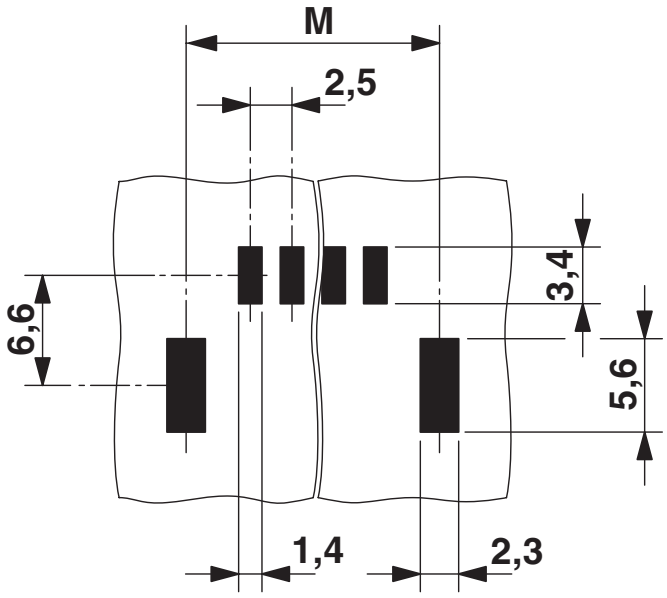


Diagram



Type: PTSM 0,5/...-2,5-H SMD WH (L) R..
Tested in accordance with DIN EN 60512-5-2:2003-01
Reduction factor = 1
Number of positions: 5

Drilling plan/solder pad geometry



Classifications

ECLASS

ECLASS-11.0	27460101
ECLASS-12.0	27460101
ECLASS-13.0	27460101

ETIM

ETIM 9.0	EC002643

UNSPSC

UNSPSC 21.0	39121400

Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions

China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%

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